

## **FEATURES**

Surface Mounting Design 5.0*5.0mm
High Current Handling Capability 5,000Α @ 8/20 μs
Low Capacitance and Insertion Loss
Quick Response and Long Service Life
Moisture sensitivity level: Level 1







Schematic Symbol

## **APPLICATION INFORMATION**

Communication equipment.

Repeaters,Modems

Telephone Interface,Line cards.

Data communication equipment.

## **AGENCY APPROVALS**

lcon	Solderability		
RoHS	Compliance with 2011/65/EU		
HF	Compliance with IEC61249-2-21:2003		
<b>P</b> 0	Mean lead free		

# **PRODUCT CHARACTERISTICS**

Lead Material	Body Material	Terminal Finish
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated



## **ELECTRICAL PARAMETER**

Parameter	Symbol	Limit	Unit
DC Blocking Voltage 1)	100V/s	280-420	V
Impulse Spark-over Voltage	At 1kV/μs	for 99 % of measured values ≤ 900	V
impuise spark-over voltage	At 1kV/µs	Typical values of distribution ≤ 850	V
Impulse Discharge Current 2)	8/20µs	5,000	A
Insulation Resistance	DC=100V	≥ 1	GΩ
Capacitance at 1MHz V <sub>DC</sub> =0.5V		≤ 1.5	pF
Operating And Storage Temperature		-40-125	°C

1) In ionized mode

2) Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21

### **ENVIRONMENTAL RELIABILITY CHARACTERISTICS**

Testing items	Technical standards		
High Temperature Storage Test Temperature: 85°C ; Time:2H			
Low Temperature Storage Test	Temperature: -40°C ; Time:2H		
Vibration	Frequency: 10-500Hz ; Amplitude: 0.15mm ; Time:45min		
Resistance of soldering heat	Temperature: 260±5°C; Time of dip soldering: 10s, 1time		

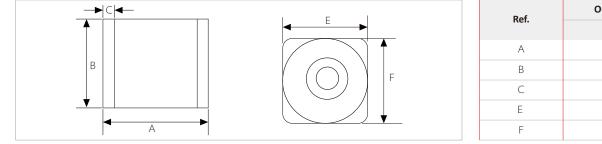
**NOTE:** Up-screen program can be specified by customer's request via contacting Semiware service



# **REFLOW PROFILE**

Reflow Condition		Lead-free assembly
	Temperature Min	150°C
Pre Heat	Temperature Max	200°C
	Time(min to max)	60 – 180 secs
Average ramp up rate (Liquidus)Temp ( $T_{L}$ ) to peak		3°C/second max
$T_s(max)$ to $T_L$ - Ramp-up Rate		5 C/ 3000110 11102
Deflering	Temperature ( $T_{L}$ ) (Liquidus)	217°C
Reflow	Time(min to max)(t <sub>s</sub> )	60 – 150 seconds
Peak Temperature (T <sub>p</sub> )		260 °C
Time with	in 5°C of actual peak Temperature (tp)	10-30 seconds
Ramp-down Rate Time 25°C to peak Temperature (T <sub>p</sub> ) Do not exceed		6°C/second max
		8 minutes max.
		260°C

# **PRODUCT DIMENSIONS AND RECOMMENDED SOLDERING PAD**



Ref.	Outline Dimensions	
	Millimeters	
A	5.0±0.3	
В	5.0±0.3	
С	0.5±0.1	
E	5.0±0.3	
F	5.0±0.3	

### **ORDERING INFORMATION**

Part Number	Size	Marking	QTY/Reel	Reel Size
SG2D05B350	5.0*5.0mm	🕢 SG350 <u>05</u>	1000PCS	13″



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#### By QR Code





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